

2U BAM SERVER

The industry's leading cybersecure, ruggedized, made-in-USA, high-performance computing solution, designed with aerospace and defense at top of mind

HARSH-ENVIRONMENT PROTECTION

All key components are stress-tested to pass stringent military standards, ensuring stability in harsh environments.

MADE IN THE USA






Trenton Systems' secure, high-performance computing solutions are designed, manufactured, assembled, integrated, tested, and supported in the USA.

FULL CONTROL & CUSTOMIZATION


Our in-house software engineers can tweak BIOS source code to bolster firmware security and configure to your exact needs.





Overview


-  Dual Intel® 3rd Gen Xeon® Ice Lake SP CPUs
-  10x PCIe Gen 4 slots
-  24x DDR4-3200 ECC RDIMM slots
-  6x NVME connectors
-  Designed to meet MIL-STD-810, DO-160, CE


CYBERSECURITY HIGHLIGHTS


 **Intel® PFR** protects against firmware attacks using an Intel® MAX 10 Field-Programmable Gate Array (FPGA).


 **Intel® SGX** includes predefined portions of memory that can better protect sensitive information.


 **Intel® Total Memory Encryption** provides encryption of a computer system's physical memory.


 **Strict revision control** is achieved through Trenton's approved vendor list (AVL), ensuring engineer-vetted parts.

 **Counterfeit Protection Program (CPP)** helps Trenton detect, remove, and destroy counterfeit parts and components.

 **Vetted supply chain** helps protect your system from potentially compromised counterfeit electronic parts and components.

 **45-Day Loaner Program** lets customers verify that they're acquiring a cybersecure computing solution that integrates seamlessly into their vetted cybersecurity infrastructure.

 **TAA compliance** is achieved because Trenton manufactures the 2U BAM, and its other solutions, in the United States.

 **CSFC and ISO9001 adherence and compliance** allow Trenton to consistently provide secure, high-quality computing solutions.



The BAM: Powerful. Durable. Protected.

- Protected by a trusted supply chain
- Protected by hardware, firmware, and software security
- Ruggedized to withstand the world's harshest conditions
- PCIe slots have no switches for maximum throughput
- Plenty of room for high-performance GPUs
- Designed to meet your exact requirements

MODEL NUMBER

BAC2000 (2U)

MOTHERBOARD

BAM8278

PROCESSORS

Intel® 3rd Gen Xeon® Scalable Processors (Ice Lake) up to 235W

MEMORY

24x DDR4-3200 ECC RDIMM slots

ON-BOARD DEVICES

- ▶ **NVMe:** 6x NVMe connectors
- ▶ **USB:** 1x USB3 header
- ▶ **IPMI:**
 - IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
 - ASPEED AST2500 BMC
- ▶ **Network Controller:**
 - Intel® i350 Gigabit Ethernet
- ▶ **Graphics:** ASPEED AST2500 VGA
- ▶ **TPM 2.0:** Infineon SLB9670

INPUT / OUTPUT

- ▶ **USB:** 4x USB 3.0 ports
- ▶ **Display:** 1x VGA port
- ▶ **LAN:** 1x RJ-45 Gigabit Ethernet port; 1x RJ-45 Gigabit Ethernet Shared IPMI port
- ▶ **Serial:** 1x RS232 serial port

PCIe GEN 4 SLOTS

- ▶ 10x PCIe Gen 4 x16 mechanical slots
- ▶ I2C connectivity
 - monitors PCIe slots and NVIDIA cards via the I2C bus

DIMENSIONS

BAC2000: 19" x 3.5" x 20" (48.26 cm x 8.89 cm x 50.8 cm)

Weight: 28 lbs. (12.7 kg)

FRONT PANEL

The front panel comes with a drive bay that supports a mixture of front-removable drives.

SYSTEM COOLING

1x PWM CPU blower fan per CPU (1U and 2U fans)

POWER / POWER SUPPLY

- ▶ **220VAC:** output power = 2850W

SYSTEM BIOS

- ▶ **BIOS Type:** 128Mb SPI NOR Flash with Insyde BIOS
- ▶ **BIOS Features:**
 - Plug and Play (PnP)
 - APM 1.2
 - PCI 2.2
 - ACPI 1.0 / 2.0
 - USB keyboard support
 - SMBIOS 2.3
 - UEFI

SYSTEM MANAGEMENT

ASPEED AST2500 baseboard management controller: rKVM, system monitoring, out-of-band management

ENVIRONMENTAL SPECIFICATIONS

- ▶ Operating Temperature: 0°C - 50°C
- ▶ Storage Temperature: -20°C - 70°C
- ▶ Operating Humidity: 5% - 90% non-condensing
- ▶ Non-Operating Humidity: 5% - 90% non-condensing
- ▶ Shock: 3 axis, 35g, 25ms
- ▶ Vibration: 4.76Grms, 10Hz to 2000 Hz (SSD)
- ▶ Altitude: 0 to 10,000 ft (3,048m)
- ▶ Non-Operating Altitude: 0 to 30,000 ft (9,144m)

**Preliminary numbers noted. Final numbers expected to outperform current specifications. [Contact us](#) for more options.*

COMPLIANCE

Designed to meet the following standards/certifications:

- ▶ MIL-STD-810H
- ▶ DO-160F
- ▶ 2014/35/EU (LVD)
- ▶ 2014/30/EU (EMC)

